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## FAIRCHILD

## FGL60N100D

## General Description

Insulated Gate Bipolar Transistors (IGBTs) with trench gate structure have superior performance in conduction and switching to planar gate structure, and also have wide noise immunity. These devices are well suitable for IH applications

## Features

- High Speed Switching
- Low Saturation Voltage : $\mathrm{V}_{\mathrm{CE}(\text { sat })}=2.5 \mathrm{~V} @ \mathrm{I}_{\mathrm{C}}=60 \mathrm{~A}$
- High Input Impedance
- Built-in Fast Recovery Diode


## Application

Home Appliance, Induction Heater, IH JAR, Micro Wave Oven


## Absolute Maximum Ratings $T_{C}=25^{\circ} \mathrm{C}$ unless otherwise noted

| Symbol | Description | FGL60N100D | Units |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CES }}$ | Collector-Emitter Voltage | 1000 | V |
| $\mathrm{V}_{\text {GES }}$ | Gate-Emitter Voltage | $\pm 25$ | V |
| $I_{C}$ | Collector Current @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 60 | A |
|  | Collector Current @ $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | 42 | A |
| $\mathrm{I}_{\text {CM (1) }}$ | Pulsed Collector Current | 120 | A |
| $\mathrm{I}_{\mathrm{F}}$ | Diode Continuous Forward Current $\quad @ \mathrm{~T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | 15 | A |
| $\mathrm{P}_{\mathrm{D}}$ | Maximum Power Dissipation @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 176 | W |
|  | Maximum Power Dissipation @ $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | 70 | W |
| $\mathrm{T}_{\mathrm{J}}$ | Operating Junction Temperature | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage Temperature Range | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Maximum Lead Temp. for soldering Purposes, $1 / 8^{\prime \prime}$ from case for 5 seconds | 300 | ${ }^{\circ} \mathrm{C}$ |

Notes:
(1) Repetitive rating: Pulse width limited by max. junction temperature

## Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Units |
| :--- | :--- | :---: | :---: | :---: |
| $\mathrm{R}_{\theta \mathrm{JC}}(\mathrm{IGBT})$ | Thermal Resistance, Junction-to-Case | -- | 0.71 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \mathrm{JC}}(\mathrm{DIODE})$ | Thermal Resistance, Junction-to-Case | -- | 2.08 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \mathrm{JA}}$ | Thermal Resistance, Junction-to-Ambient | -- | 25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## Electrical Characteristics of IGBT $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted

| Symbol | Test Conditions | Min. | Typ. | Max. | Units |  |
| :--- | :--- | :--- | :--- | :--- | :---: | :---: |
|  |  |  |  |  |  |  |
| Off Characteristics |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CES}}$ | Collector Cut-Off Current | $\mathrm{V}_{\mathrm{CE}}=1000 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V}$ | -- | -- | 1.0 | mA |
| $\mathrm{I}_{\mathrm{GES}}$ | G-E Leakage Current | $\mathrm{V}_{\mathrm{GE}}= \pm 25, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V}$ | -- | -- | $\pm 500$ | nA |

On Characteristics

| $\mathrm{V}_{\mathrm{GE}(\mathrm{h})}$ | $\mathrm{G}-\mathrm{E}$ Threshold Voltage | $\mathrm{I}_{\mathrm{C}}=60 \mathrm{~mA}, \quad \mathrm{~V}_{\mathrm{CE}}=\mathrm{V}_{\mathrm{GE}}$ | 4.0 | 5.0 | 7.0 | V |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{CE}(\text { sat })}$ | Collector to Emitter | Saturation Voltage | $\mathrm{I}_{\mathrm{C}}=10 \mathrm{~A}, \quad \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}$ | -- | 1.6 | 2.0 |
|  | $\mathrm{I}_{\mathrm{C}}=60 \mathrm{~A}, \quad \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}$ | -- | 2.5 | 2.9 | V |  |

Dynamic Characteristics

| $\mathrm{C}_{\text {ies }}$ | Input Capacitance | $\mathrm{V}_{\mathrm{CE}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V}$ | -- | 6300 | -- | pF |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {oes }}$ | Output Capacitance |  | -- | 160 | -- | pF |
| $\mathrm{C}_{\text {res }}$ | Reverse Transfer Capacitance |  | -- | 140 | -- | pF |

## Switching Characteristics

| $\mathrm{t}_{\mathrm{d} \text { (on) }}$ | Turn-On Delay Time | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=600 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=60 \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{G}}=51 \Omega, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}, \\ & \text { Resistive Load, } \mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} \end{aligned}$ | -- | 160 | 400 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time |  | -- | 360 | 700 | ns |
| $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | Turn-Off Delay Time |  | -- | 410 | 700 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  | -- | 240 | 330 | ns |
| $\mathrm{Q}_{\mathrm{g}}$ | Total Gate Charge | $\begin{aligned} & \mathrm{V}_{\mathrm{CE}}=600 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=60 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V} \end{aligned}$ | -- | 230 | 300 | nC |
| $\mathrm{Q}_{\mathrm{ge}}$ | Gate-Emitter Charge |  | -- | 45 | -- | nC |
| $\mathrm{Q}_{\mathrm{gc}}$ | Gate-Collector Charge |  | -- | 80 | -- | nC |

## Electrical Characteristics of DIODE $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{FM}}$ | Diode Forward Voltage | $\mathrm{I}_{\mathrm{F}}=15 \mathrm{~A}$ | -- | 1.2 | 1.7 | V |
|  |  | $\mathrm{I}_{\mathrm{F}}=60 \mathrm{~A}$ | -- | 1.8 | 2.1 | V |
| $\mathrm{t}_{\mathrm{rr}}$ | Diode Reverse Recovery Time | $\mathrm{I}_{\mathrm{F}}=60 \mathrm{Adi} / \mathrm{dt}=-20 \mathrm{~A} / \mathrm{us}$ |  | 1.2 | 1.5 | us |
| $\mathrm{I}_{\mathrm{R}}$ | Instantaneous Reverse Current | $\mathrm{V}_{\mathrm{RRM}}=1000 \mathrm{~V}$ | -- | 0.05 | 2 | uA |



Fig 1. Typical Output Characteristics


Fig 3. Saturation Voltage vs. Case Temperature at Varient Current Level


Fig 5. Saturation Voltage vs. $\mathrm{V}_{\mathrm{GE}}$


O00LN0975=

Fig 2. Typical Saturation Voltage Characteristics


Fig 4. Saturation Voltage vs. $\mathrm{V}_{\mathrm{GE}}$


Fig 6. Saturation Voltage vs. $\mathbf{V}_{\text {GE }}$


Fig 7. Capacitance Characteristics


Fig 9. Switching Characteristics vs. Collector Current


Fig 11. SOA Characteristics


Fig 8. Switching Characteristics vs. Gate Resistance


Fig 10. Gate Charge Characteristics


Fig 12. Transient Thermal Impedance of IGBT


Fig 13. Forward Characteristics


Fig 15. Reverse Recovery Characteristics vs. Forward Current


Fig 17. Junction capacitance


Fig 14. Reverse Recovery Characteristics vs. di/dt


Fig 16. Reverse Current vs. Reverse Voltage

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| :--- | :--- | :--- |
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